# μPD5750T7D

SiGe BiCMOS Integrated Circuit Wide Band LNA IC with Through Function R09DS0009EJ0100 Rev.1.00 Feb 24, 2011

# DESCRIPTION

The  $\mu$ PD5750T7D is a low noise wideband amplifier IC mainly designed for the portable digital TV application. This IC exhibits low noise figure and high power gain characteristics. The  $\mu$ PD5750T7D has an LNA pass-through function (bypass function) to prevent the degradation of the received signal quality at the strong electric field, and achieve the high reception sensitivity and low power consumption.

The package is a 6-pin WLBGA (Wafer Level Ball Grid Array) (T7D) suitable for surface mount.

This IC is manufactured using our latest SiGe BiCMOS process that shows superior high frequency characteristics.

# FEATURES

٠	Low voltage operation	: $V_{CC} = 1.8 \text{ V TYP}$ .
٠	Low mode control voltage	: $V_{\text{cont (H)}} = 1.0 \text{ V}$ to $V_{\text{CC}}$ , $V_{\text{cont (L)}} = 0$ to 0.4 V
٠	Low current consumption	: $I_{CC} = 3.1 \text{ mA TYP.}$ @V <sub>CC</sub> = 1.8 V (LNA-mode)
		: $I_{CC} = 1 \ \mu A MAX. @V_{CC} = 1.8 V (Bypass-mode)$
٠	Low noise	: NF = 1.5 dB TYP. $@V_{CC} = 1.8 \text{ V}, \text{ f} = 470 \text{ MHz}$
	(LNA-mode)	: NF = 1.4 dB TYP. $@V_{CC} = 1.8 \text{ V}, f = 770 \text{ MHz}$
٠	High gain	: $G_P = 13.5 \text{ dB TYP}$ . @ $V_{CC} = 1.8 \text{ V}$ , f = 470 MHz
	(LNA-mode)	: $G_P = 12.5 \text{ dB TYP}$ . @ $V_{CC} = 1.8 \text{ V}$ , f = 770 MHz
٠	Low insertion loss	: $L_{ins} = 1.2 \text{ dB TYP}$ . @V <sub>CC</sub> = 1.8 V, f = 470 MHz
	(Bypass-mode)	: $L_{ins} = 1.4 \text{ dB TYP}$ . @ $V_{CC} = 1.8 \text{ V}$ , f = 770 MHz
٠	High-density surface mounting	: 6-pin WLBGA (0.73 × 0.48 × 0.26 mm)

• Included protection circuit for ESD

# APPLICATIONS

• Low noise amplifier for the portable and mobile digital TV system, etc.

## **ORDERING INFORMATION**

Part Number	Order Number	Package	Marking	Supplying Form
μPD5750T7D-E4A	μPD5750T7D-E4A-A	6-pin WLBGA	A	Embossed tape 8 mm wide
		(T7D)		• Pin A3, B3 face the perforation side of the tape
		(Pb-Free)		Qty 10 kpcs/reel

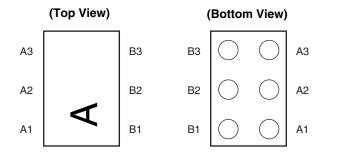
**Remark** To order evaluation samples, please contact your nearby sales office. Part number for sample order:  $\mu$ PD5750T7D

### CAUTION

Observe precautions when handling because these devices are sensitive to electrostatic discharge.

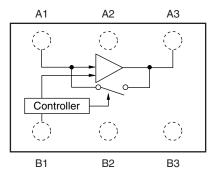


## PIN CONNECTIONS AND MARKING



Pin No	Pin Name
A1	INPUT
A2	GND1
A3	OUTPUT
B1	V <sub>cont</sub>
B2	GND2
B3	Vcc

## INTERNAL BLOCK DIAGRAM



### **TRUTH TABLE**

Vcont	Gain	Mode
Н	High	LNA-mode
L	Low	Bypass-mode

**Remark** "H" =  $V_{\text{cont (H)}}$ , "L" =  $V_{\text{cont (L)}}$ 

## ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V <sub>cc</sub>	3.6	V
Mode Control Voltage	V <sub>cont</sub>	3.6	V
Operating Ambient Temperature	T <sub>A</sub>	–40 to +85	°C
Storage Temperature	T <sub>stg</sub>	–55 to +150	°C
Input Power	P <sub>in</sub>	+30	dBm

# **RECOMMENDED OPERATING RANGE (T<sub>A</sub> = +25°C, unless otherwise specified)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V <sub>CC</sub>	1.6	1.8	2.0	V
Mode Control Voltage (H)	V <sub>cont (H)</sub>	1.0	—	Vcc	V
Mode Control Voltage (L)	V <sub>cont (L)</sub>	0	—	0.4	V
Operating Frequency	f	50	—	1 800	MHz
Operating Ambient Temperature	TA	-40	_	+85	°C
Input Power (LNA-mode)	Pin		_	+7	dBm
Input Power (Bypass-mode)	Pin		—	+15	dBm



# ELECTRICAL CHARACTERISTICS 1 (DC Characteristics) $(T_A = +25^{\circ}C, V_{CC} = 1.8 \text{ V}, \text{ unless otherwise specified})$

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current 1	I <sub>cc</sub> 1	V <sub>cont</sub> = 1.8 V, No Signal (LNA-mode)	1.6	3.1	4.5	mA
Circuit Current 2	I <sub>CC</sub> 2	V <sub>cont</sub> = 0 V, No Signal (Bypass-mode)	-	-	1	μA
Mode Control Current 1	I <sub>cont</sub> 1	V <sub>cont</sub> = 1.8 V, No Signal (LNA-mode)	_	20	30	μA
Mode Control Current 2	I <sub>cont</sub> 2	V <sub>cont</sub> = 0 V, No Signal (Bypass-mode)	_	_	1	μA

### ELECTRICAL CHARACTERISTICS 2 (LNA-mode) ( $T_A = +25^{\circ}C$ , $V_{CC} = V_{cont} = 1.8 V$ , $Z_S = Z_L = 50 \Omega$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Power Gain 1	G <sub>P</sub> 1	$f = 470 \text{ MHz}, P_{in} = -30 \text{ dBm}, \text{ excluded}$ PCB and connector losses <b>Note 1</b>	10.5	13.5	16.5	dB
Power Gain 2	G <sub>P</sub> 2	$f = 770 \text{ MHz}, P_{in} = -30 \text{ dBm}, \text{ excluded}$ PCB and connector losses <b>Note 1</b>	9.5	12.5	15.5	dB
Noise Figure 1	NF1	f = 470 MHz, excluded PCB and connector losses <b>Note 2</b>	Ι	1.5	2.0	dB
Noise Figure 2	NF2	f = 770 MHz, excluded PCB and connector losses <b>Note 2</b>	-	1.4	2.0	dB
Output Return Loss 1	RL <sub>out</sub> 1	f = 470 MHz, P <sub>in</sub> = –30 dBm	6.5	8.5	-	dB
Output Return Loss 2	RL <sub>out</sub> 2	f = 770 MHz, P <sub>in</sub> = –30 dBm	6.0	8.0	-	dB
Input 3rd Order Intercept Point 1	IIP₃1	f1 = 470 MHz, f2 = 471 MHz, P <sub>in</sub> = –30 dBm	-15	-11	_	dBm
Input 3rd Order Intercept Point 2	IIP <sub>3</sub> 2	f1 = 770 MHz, f2 = 771 MHz, P <sub>in</sub> = –30 dBm	-12	-8	_	dBm

Notes: 1. Input-output PCB and connector losses : 0.20 dB (at 470 MHz), 0.27 dB (at 770 MHz)

2. Input PCB and connector losses : 0.10 dB (at 470 MHz), 0.14 dB (at 770 MHz)

### ELECTRICAL CHARACTERISTICS 3 (Bypass-mode) ( $T_A = +25^{\circ}C$ , $V_{CC} = 1.8$ V, $V_{cont} = 0$ V, $Z_S = Z_L = 50 \Omega$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	L <sub>ins</sub> 1	$f = 470 \text{ MHz}, P_{in} = -10 \text{ dBm}, \text{ excluded}$ PCB and connector losses <b>Note</b>	-	1.2	2.0	dB
Insertion Loss 2	L <sub>ins</sub> 2	$f = 770 \text{ MHz}, P_{in} = -10 \text{ dBm}, \text{ excluded}$ PCB and connector losses <b>Note</b>	Ι	1.4	2.0	dB
Input Return Loss 1	RL <sub>in</sub> 1	f = 470 MHz, P <sub>in</sub> = –10 dBm	10	17	-	dB
Input Return Loss 2	RL <sub>in</sub> 2	f = 770 MHz, P <sub>in</sub> = –10 dBm	10	14	-	dB
Output Return Loss 1	RL <sub>out</sub> 1	f = 470 MHz, P <sub>in</sub> = –10 dBm	10	17	-	dB
Output Return Loss 2	RL <sub>out</sub> 2	f = 770 MHz, P <sub>in</sub> = –10 dBm	10	14	-	dB
Input 3rd Order Intercept Point	IIP <sub>3</sub>	f1 = 770 MHz, f2 = 771 MHz, P <sub>in</sub> = –2.5 dBm	+25	+32	-	dBm

Note: Input-output PCB and connector losses : 0.20 dB (at 470 MHz), 0.27 dB (at 770 MHz)



STANDARD CHARACTERISTICS FOR REFERENCE 1 (LNA-mode)
$(T_A = +25^{\circ}C, V_{CC} = V_{cont} = 1.8 V, Z_S = Z_L = 50 \Omega$ , unless otherwise specified)

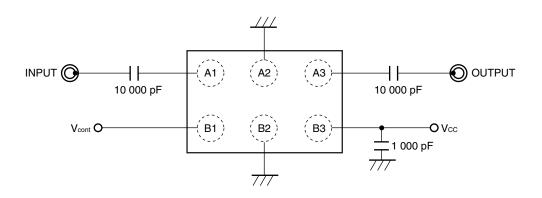
Parameter	Symbol	Test Conditions		Reference Value	Unit
Isolation 1	ISL1	f = 470 MHz, P <sub>in</sub> = –30 dBm		-30	dB
Isolation 2	ISL2	f = 770 MHz, P <sub>in</sub> = –30 dBm		-25	dB
Input Return Loss 1	RL <sub>in</sub> 1	f = 470 MHz, P <sub>in</sub> = –30 dBm		1.7	dB
Input Return Loss 2	RL <sub>in</sub> 2	f = 770 MHz, P <sub>in</sub> = –30 dBm		2.5	dB
Input Impedance 1	Z <sub>in</sub> 1	f = 470 MHz, P <sub>in</sub> = –30 dBm	Note	0.50 – j 2.01	Ω
Input Impedance 2	Z <sub>in</sub> 2	f = 770 MHz, P <sub>in</sub> = –30 dBm	Note	0.36 – j 1.21	Ω
Gain 1 dB Compression Output Power 1	P <sub>O (1 dB)</sub> 1	f = 470 MHz		–12	dBm
Gain 1 dB Compression Output Power 2	P <sub>O (1 dB)</sub> 2	f = 770 MHz		-12	dBm

Note: Calibration reference plane : Device edge side

# STANDARD CHARACTERISTICS FOR REFERENCE 2 (Bypass-mode) $(T_A = +25^{\circ}C, V_{CC} = 1.8 \text{ V}, V_{cont} = 0 \text{ V}, Z_S = Z_L = 50 \Omega$ , unless otherwise specified)

Parameter	Symbol	Test Conditions	Reference Value	Unit
Gain 1 dB Compression Output	P <sub>O (1 dB)</sub>	f = 770 MHz	+6	dBm
Power				

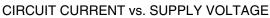
# **TEST CIRCUIT**

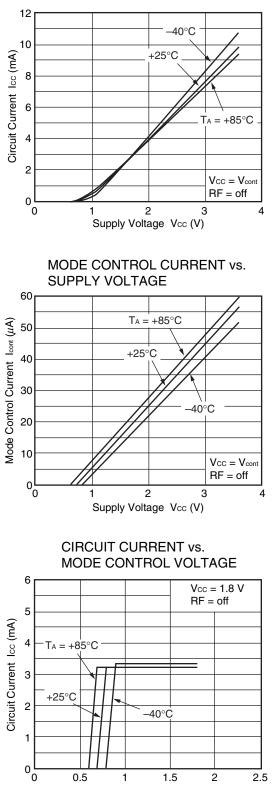




# **TYPICAL CHARACTERISTICS 1 (DC Characteristics)**

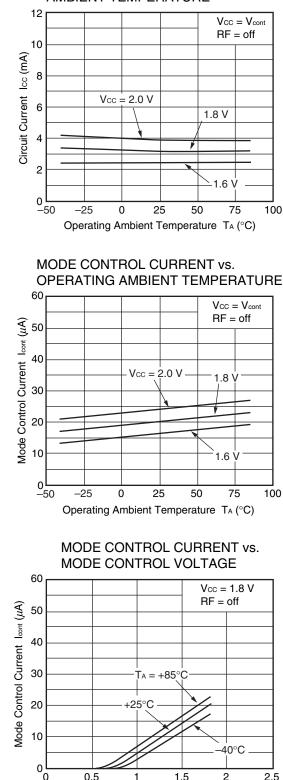
# (T<sub>A</sub> = +25°C, unless otherwise specified)





Remark The graphs indicate nominal characteristics.

Mode Control Voltage Vcont (V)



0.5

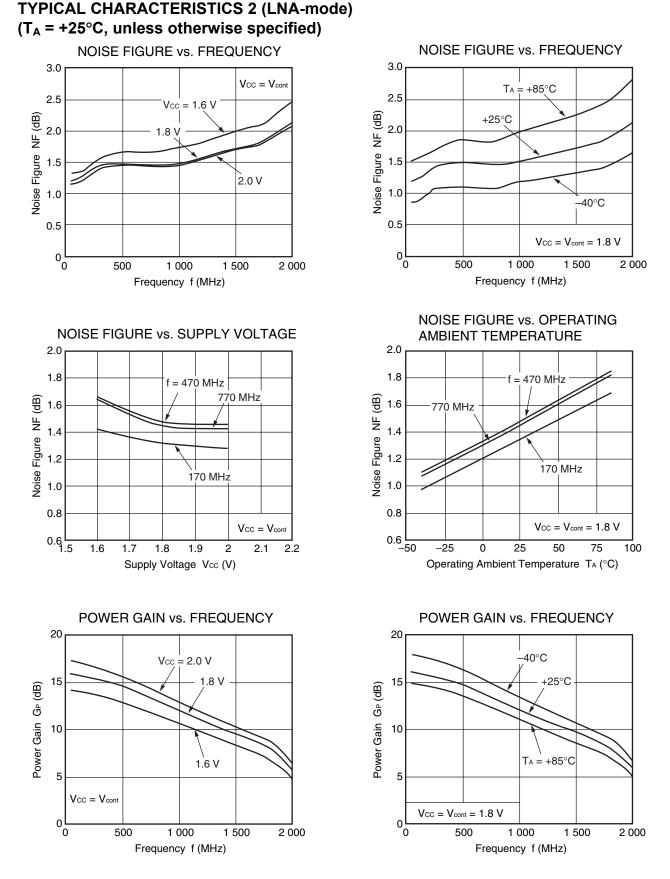
1.5

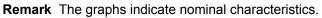
Mode Control Voltage Vcont (V)

2

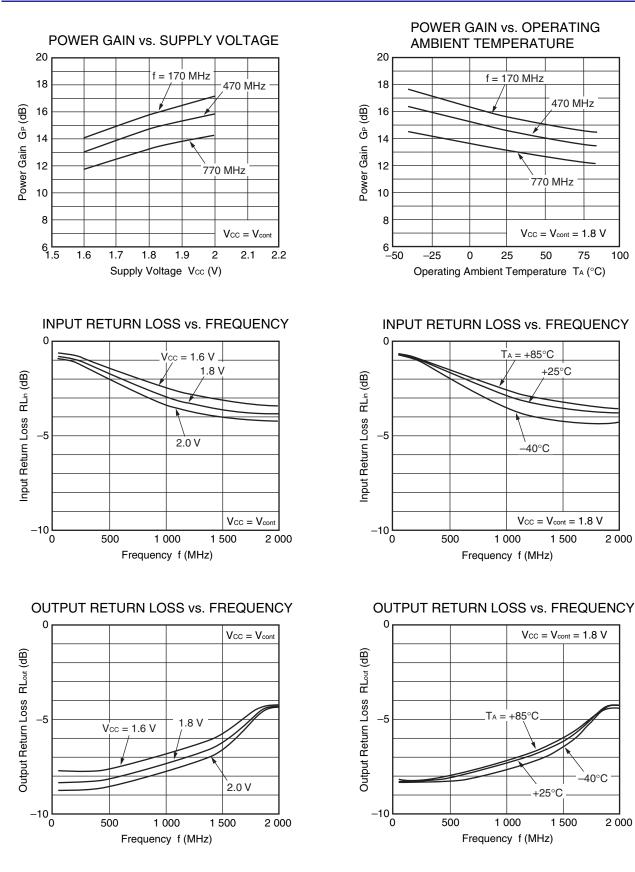
#### **CIRCUIT CURRENT vs. OPERATING** AMBIENT TEMPERATURE

2.5



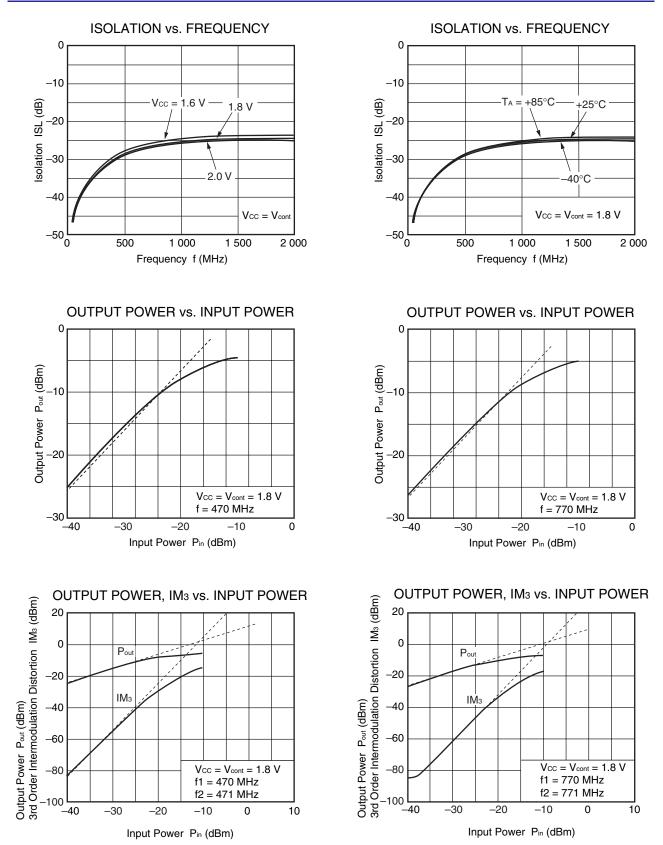






 $\label{eq:result} \textbf{Remark} \ \ \textbf{The graphs indicate nominal characteristics}.$ 





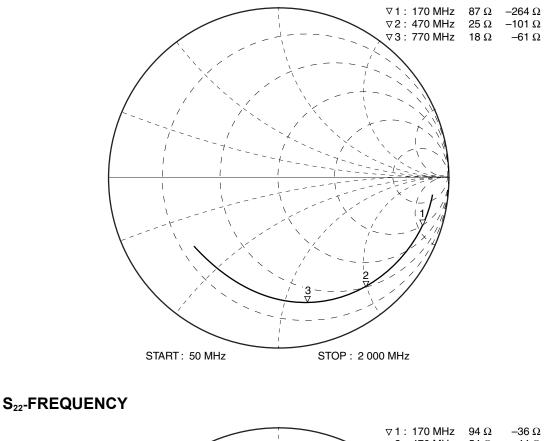


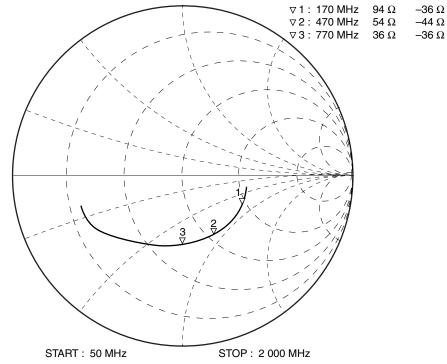


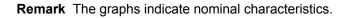
## S-PARAMETERS 1 (LNA-mode)

 $(T_A = +25^{\circ}C, V_{CC} = V_{cont} = 1.8 V, Calibration reference plane: Device edge side)$ 

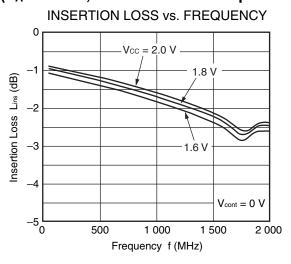
## S<sub>11</sub>-FREQUENCY

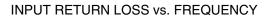


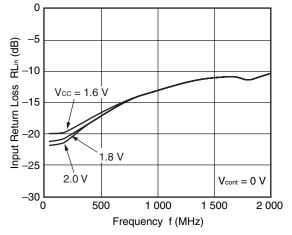




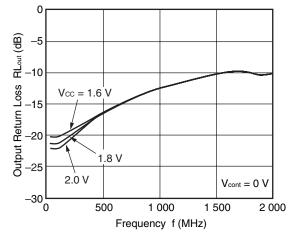
# TYPICAL CHARACTERISTICS 3 (Bypass-mode) $(T_A = +25^{\circ}C, unless otherwise specified)$

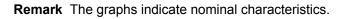


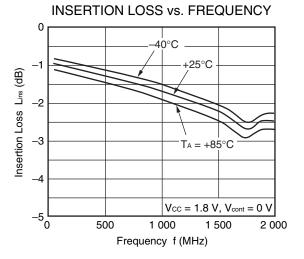




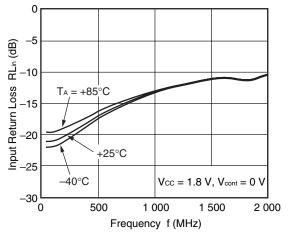
**OUTPUT RETURN LOSS vs. FREQUENCY** 



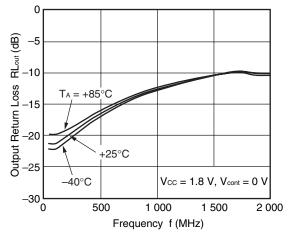


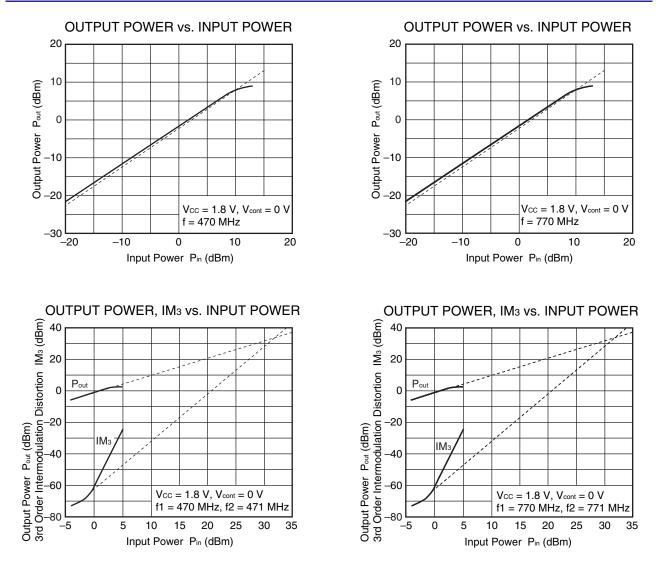


INPUT RETURN LOSS vs. FREQUENCY



OUTPUT RETURN LOSS vs. FREQUENCY





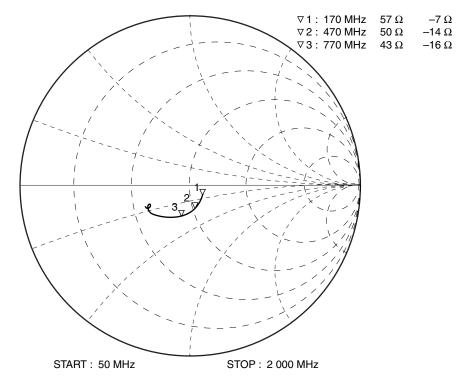
Remark The graphs indicate nominal characteristics.



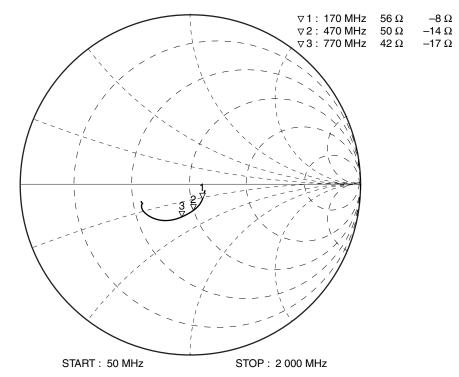
## S-PARAMETERS 2 (Bypass-mode)

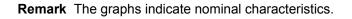
(T<sub>A</sub> = +25°C, V<sub>CC</sub> = 1.8 V, V<sub>cont</sub> = 0 V, Calibration reference plane: Device edge side)

## S<sub>11</sub>-FREQUENCY



## S<sub>22</sub>-FREQUENCY

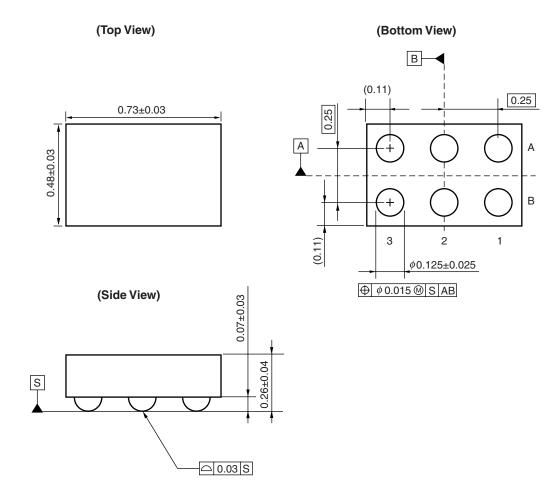






## PACKAGE DIMENSIONS

## 6-PIN WLBGA (T7D) (UNIT: mm)



Remark (): Reference value



## NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground terminals must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to  $V_{CC}$  line.
- (4) Do not supply DC voltage to INPUT pin.

## **RECOMMENDED SOLDERING CONDITIONS**

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

CAUTION

Do not use different soldering methods together.



# $\mu$ PD5750T7D Data Sheet

		Description	
Rev.	Date	Page	Summary
1.00	Feb 24, 2011	_	First edition issued

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